

•General Description

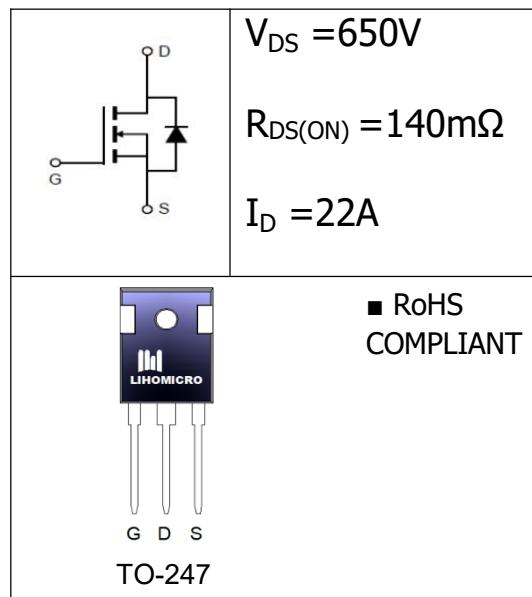
The SJ MOSFET LH65R140 has the low $R_{DS(on)}$, low gate charge, fast switching and excellent avalanche characteristics. This device offers extremely fast and robust body diode, and is suitable for telecom and power supplies.

•Features

- Low Power Loss By High Speed Switching
- Low On-Resistance

•Application

- DC-DC Converter
- UPS-Micro Inverter System
- PFC Power Supply


•Ordering Information:

Part number	LH65R140		
Package	TO-247		
Basic ordering unit (pcs)	330		
Normal Package Material Ordering Code	LH65R140T2-TO247-TU		
Halogen Free Ordering Code	LH65R140T2-TO247-TU-HF		

•Absolute Maximum Ratings (TC = 25°C)

PARAMETER	SYMBOL	Value	UNIT
Drain-Source Breakdown Voltage	BV_{DSS}	650	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current TC = 25°C TC = 100°C	I_D	22	A
		14	
Pulsed drain current (TC = 25°C, tp limited by Tjmax) ¹	I_D pulse	66	A
Single Pulse Avalanche Energy ¹	I_{AR}	4.2	A
Single Pulse Avalanche Energy ²	E_{AS}	484	mJ
Repetitive Avalanche Energy ¹	E_{AR}	0.7	mJ
Power Dissipation(TC=25°C)	P_D	151	W
Operating Temperature and Storage Temperature Range	T_J/T_{STG}	-55~+150	°C
Reverse Diode dv/dt ³	dv/dt	50	V/ns
Maximum Diode Commutation Speed ³	di/dt	900	A/ns

•Electronic Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650	--	--	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	--	4.5	V
Drain-source On Resistance ³	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 7.5A$	--	0.12	0.14	Ω
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^\circ C$	--	--	1	μA
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 125^\circ C$	--	--	100	
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 30$	--	--	± 100	nA
Forward Transconductance ³	R_G	f=1.0MHz open drain	--	--	12	Ω
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 100V, f = 1.0MHz$	--	1834	--	pF
Output Capacitance	C_{oss}		--	57	--	
Reverse transfer Capacitance	C_{rss}		--	1.7	--	
Turn-on delay time	$T_{d(on)}$	$V_{DD} = 400V, I_D = 20A, R_G = 25\Omega$	--	34	--	nS
Rise time	T_r		--	72	--	
Turn -Off Delay Time	$T_{d(off)}$		--	114	--	
Fall time	T_f		--	41	--	
Total Gate Charge	Q_g	$I_D = 20A, V_{DS} = 520V, V_{GS} = 10V$	--	42	---	nC
Gate-to-Source Charge	Q_{gs}		--	10	--	
Gate-to-Drain Charge	Q_{gd}		--	17	---	
Continuous Diode Forward Current	I_s		--	--	20	A
Pulsed Diode Forward Current	I_{SM}		--	--	60	A
Diode Forward Voltage	V_{SD}	$T_J = 25^\circ C, I_s = 20A, V_{GS} = 0V$	--	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_{RR} = 400V, I_f = I_s, dI_f/dt = 100A/\mu s$	--	198	--	ns
Reverse Recovery Charge	Q_{rr}		--	0.54	--	μC
Peak Reverse Recovery Current	I_{RRM}		--	60	--	A

•Thermal Characteristics

PARAMETER	SYMBOL	MAX	UNIT
Thermal Resistance Junction-case	R_{thJC}	0.83	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thJA}	62	$^\circ C/W$

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. $I_{AS} = 4.2A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ C$

3. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

- **Typical Characteristics** $T_J=25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

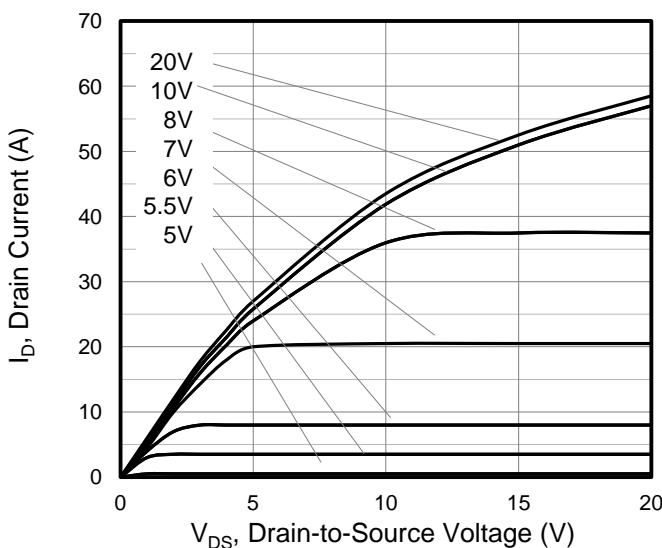


Figure 2. Transfer Characteristics

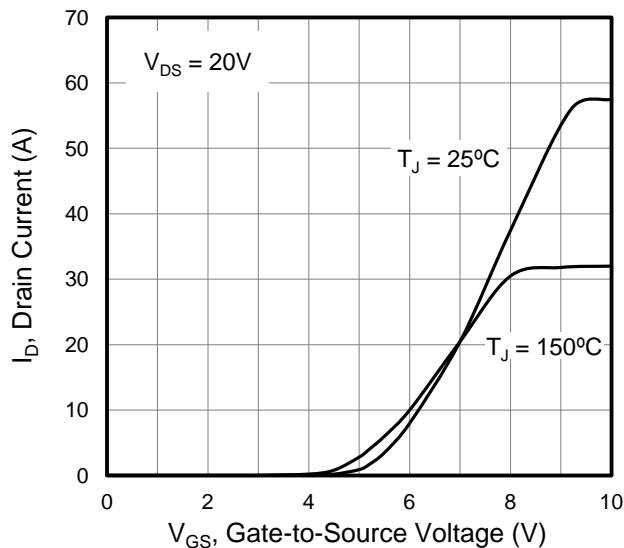


Figure 3. On-Resistance vs. Drain Current

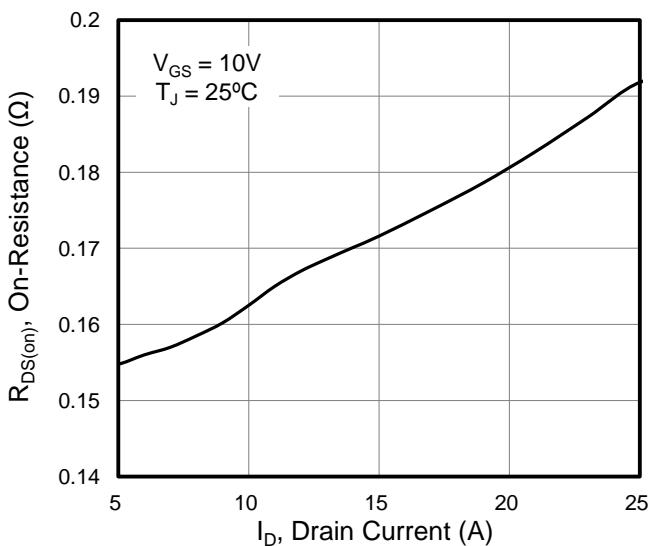


Figure 4. Capacitance

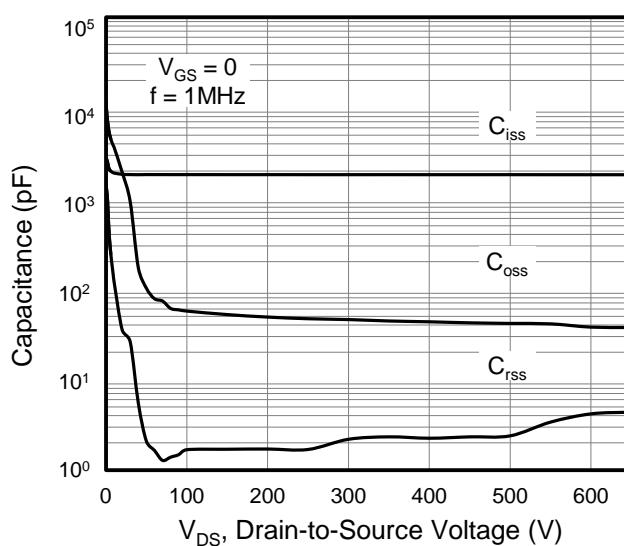


Figure 5. Gate Charge

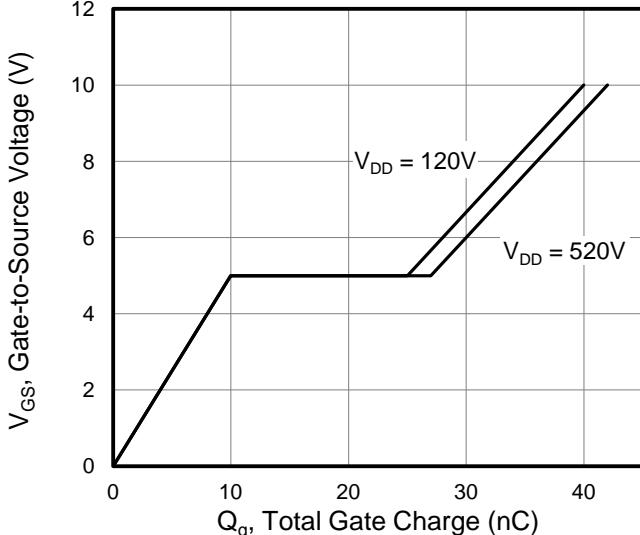
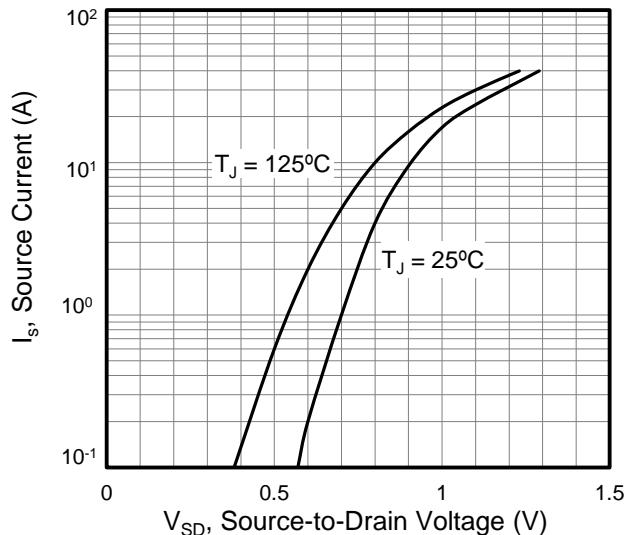
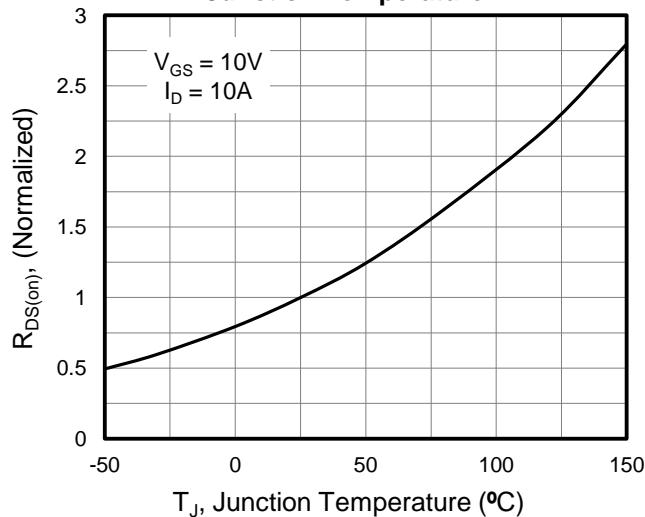
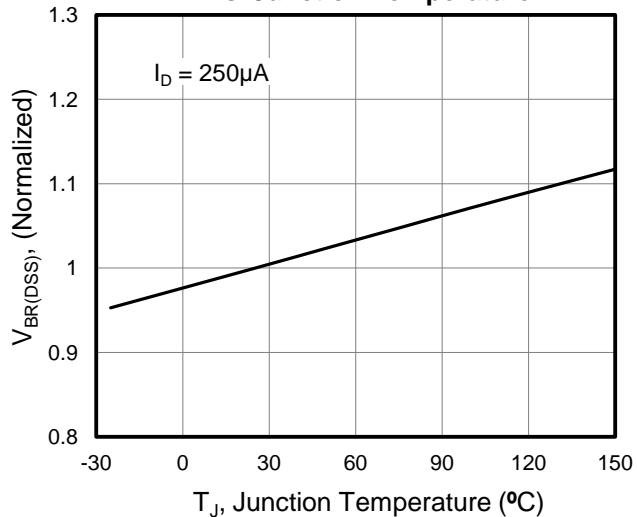
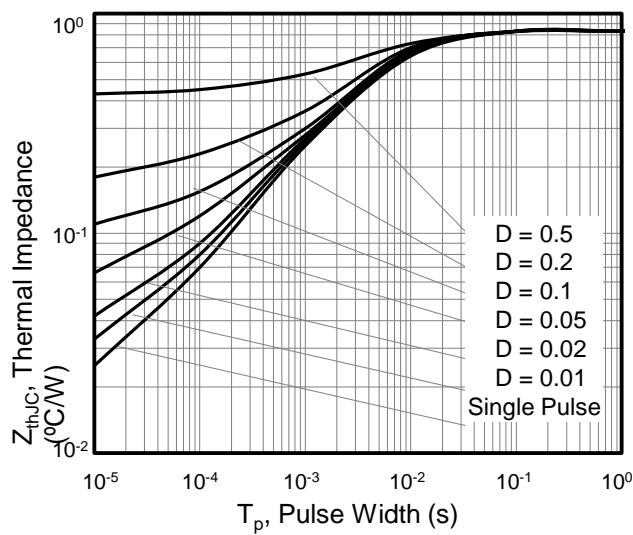
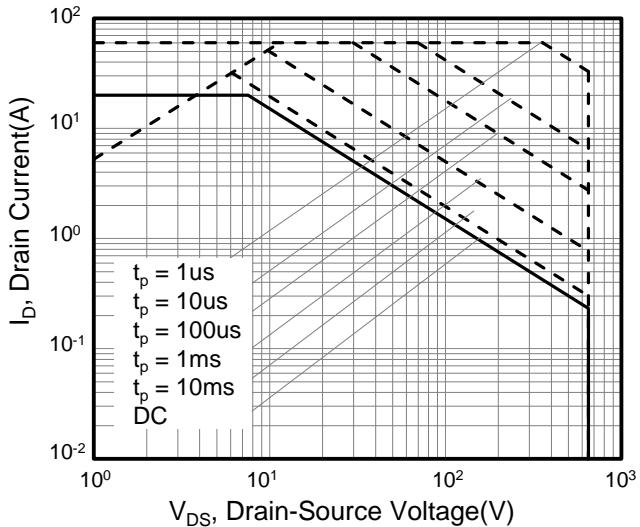
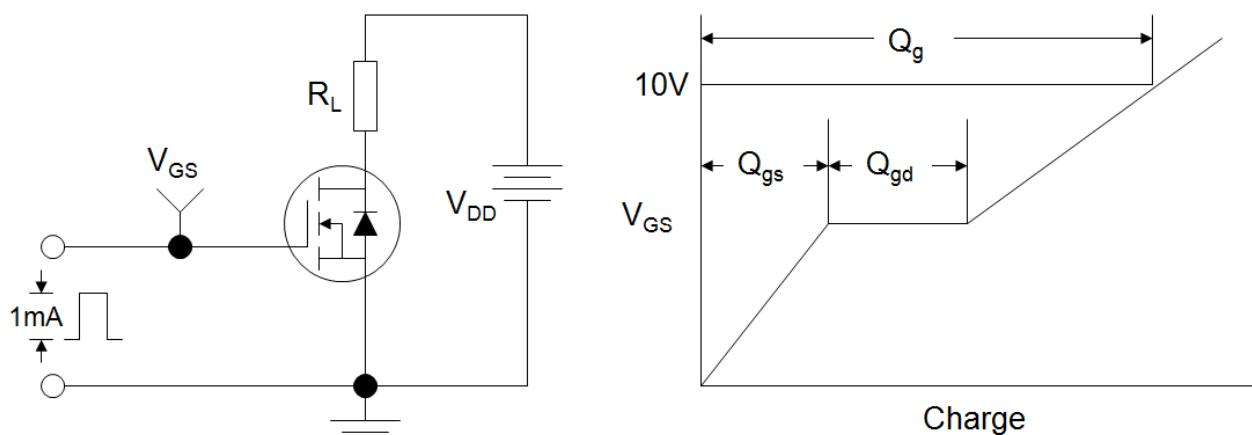
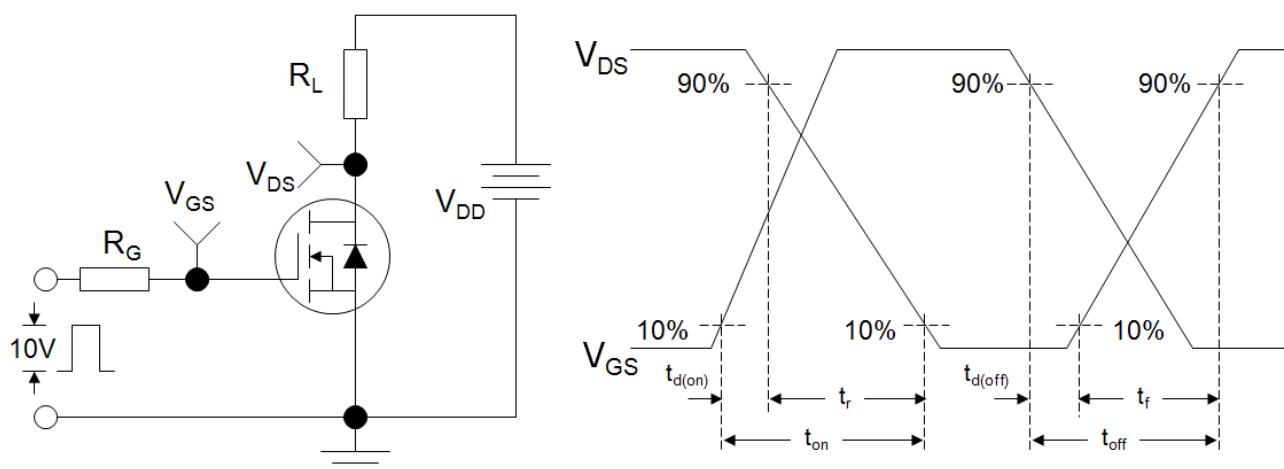
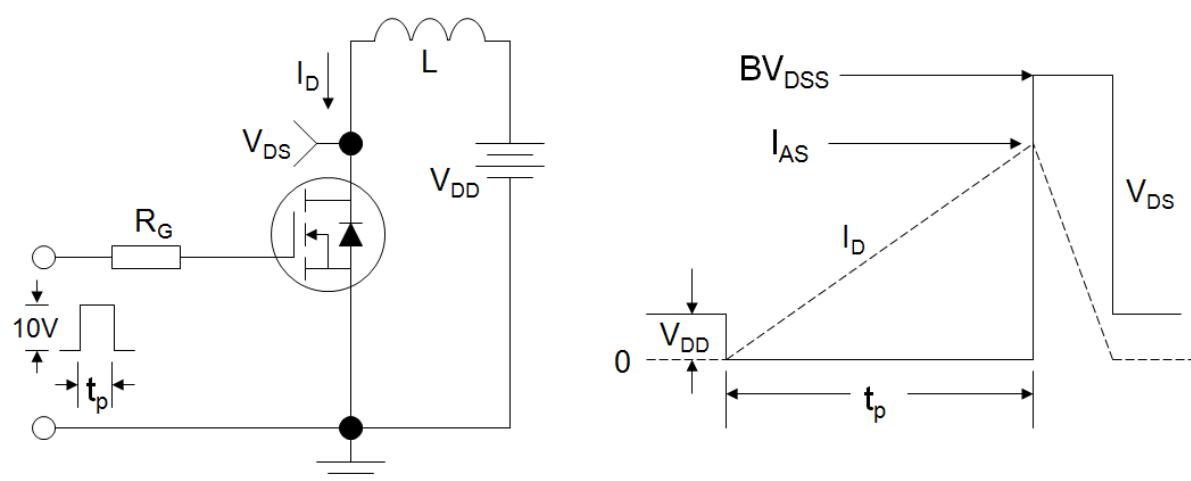


Figure 6. Body Diode Forward Voltage



•Typical Characteristics(Cont.)
Figure 7. On-Resistance vs. Junction Temperature

Figure 8. Breakdown voltage vs. Junction Temperature

Figure 9 . Transient Thermal Impedance

Figure 10. Safe operation area


•Test Circuit and Waveforms
Figure A: Gate Charge Test Circuit and Waveform

Figure B: Resistive Switching Test Circuit and Waveform

Figure C: Unclamped Inductive Switching Test Circuit and Waveform


•Dimensions (TO-247)

UNIT:mm

SYMBOL	min	max	SYMBOL	min	max
A	15.60	16.00	G2	1.95	2.25
B	20.80	21.20	N	5.25	5.65
C	4.85	5.15	L1	4.00	4.30
D	1.85	2.15	L	19.60	20.40
E	1.00	1.40	I	2.30	2.50
F	0.50	0.70	ΦP	3.30	3.70
G1	3.00	3.30			

